AS	PC	© Co	terial Compo pyright 2005. IPC, Bannoc Iternational and Pan-Americ	kburn, Illinois	All rights reserve	tion with lower	level p	oarts, the	declaratio	n encom	passes	all lower	level mate	erials for	which th	e item is an assembly ne manufacturer has leclaration.
1752-2 1.1 IPC Web Site for Inform http://www.ipc.org/IPC					-1752 Standa	rd		Form Type *Declaration Class *DistributeClass 6 - RoHS Yes/No, Homogeneous Materials and Mfg							s and Mfg Informat	
Supplier Information																
Con	npany Name *		Company Unique ID		Unique ID Au	Ithority	Resp	Response Date * Response Document ID								
SEMTECH CORPORATION 00-847-99			00-847-9941		DUNS		2016-	08-08								
Contact Name * T			Title - Contact	Phone - Contact *				Email - Contact *					Orighteret	A t.l		
Roy	va Motamedi		Supervisor, QA Prod	uct Suppor	805-498-2111			rmotamedi@semtech.com			Duplicate Contact -> Authorized Representative					presentative
Aut	Authorized Representative		Title - Representative	е	Phone - Representative *			Email - Representative *			Supplier Comments or URL for Additional Information					
Roy	a Motamedi		Supervisor, QA Prod	luct Suppo	805-498-2111			rmotamedi@semtech.com								
Requester Item Number		r	Mfr Item Number		Mfr Item Name		Effectiv	ve Date	Version	Manufac	turing S	ite	Weight *	UC	M	Unit Type
			TS30041-QFNR	30041-QFNR High Effic		Efficiency 1A/2A Current-M		Chin		China	a		24.32		I	Each
	Alternate Recommenda	ation						Alternate Item C		Item Con	omments					
Ма	Manufacturing Process Information															
Terminal Plating / Grid Array Material		al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	iting	Peak Process Body Ter		Femperature N		Max Time at Peak Tempe		perature	rature Number of Reflow Cyc		
Other				CU Alloy		1		260				30 seconds		conds	3	
	ments 0041-QFNR is REAC	H-cor	mpliant product, per	r EU Regu	lation EC190	7/2006 to include	recen	t additior	n of SVH	C candi	date lis	st of sub	stances in	n June 2	2016.	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Woight	Unit of	Tolerance		РРМ
	Name		Material	weight	Measure		Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	
+1 -1	Lead frame	+M -M	NiPdAuAg	8.24	mg	+C -C	Supplier		+S	-S	Copper	7440-50-8		7.928	mg			326,00
									+S	-S	Zinc	7440-66-6		0.00824	mg			338.82
									+S	-s	Ferrous	7439-89-6		0.1895	mg			7,792.7
									+S	-s	Phosphorus	7723-14-0		0.00577	mg			237.17
						+C -C	A	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.00082	mg			33.88
						+C -C	в		+S	-s	Nickel	7440-02-0		0.0988	mg			4,065.7
						+C -C	Supplier		+S	-S	Gold	7440-57-5		0.00247	mg			101.64
									+S	-s	Silver	7440-22-4		0.00165	mg			67.76
									+S	-s	Palladium	7440-05-3		0.00412	mg			169.41
+I -I	Die	+M -M	Silicon chip	1.27	mg	+C -C	Supplier		+S	-S	Si	7440-21-3		1.27	mg		:	52,220
+ -	Ероху	+M -M	QMI519	0.31	mg	+C -C	Supplier		+S	-S	Silver	7440-22-4		0.2495	mg			10,261
	-		-		•		-		+S	-s	2-Propionic acid, methy	Proprietary		0.0496	mg			2,039.4
									+S	-s	2-Propenoic acid, 2-met	68586-19-6		0.0093	mg			382.4
									+S	-s	Bis(.alpha.,.alphaDime	80-43-3		0.00062	mg			25.49
									+S	-s	2-(3,4-Epoxycyclohexyl	3388-04-3		0.00093	mg			38.24
+ -	Wire	+M -M	1.2 Cu	0.12	mg	+C -C	Supplier		+S	-s	Copper	7440-50-8		0.1158	mg		ŀ	4,761.5
	-		-		•		-		+S	-s	Palladium	7440-05-3		0.0036	mg			148.03
									+S	-s	Au	7440-57-5		0.0006	mg			24.67
+ -	Mold compound	+M -M	EME-G770HCD	14.38	mg	+C -C	Supplier		+S	-s	Epoxy resin	Proprietary		0.4314	mg			17,738
							-		+S	-s	Phenol resin	Proprietary		0.4314	mg			17,738
									+S	-s	Silica (Amorphous) A	60676-86-0		11.54	mg			474,50
									+S	-s	Silica (Amorphous) B	7631-86-9		1.941	mg			79,823
									+S	-s	Carbon Black	1333-86-4		0.03595	mg			1,478.2

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